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P-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
- 100	0.08 at V _{GS} = - 10 V	- 25	17.9		
	0.09 at V _{GS} = - 4.5 V	- 20	17.9		

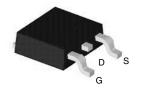
FEATURES

- DT-Trench Power MOSFET
- + 100 % $\rm R_g$ and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

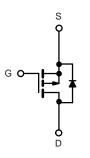
APPLICATIONS

- Power Switch
- DC/DC Converters

TO-252 Pin Configuration



Top View



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_{C} = 25 \text{ °C}$, unless otherwise noted						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	- 100	M			
Gate-Source Voltage	V _{GS}	± 20	V			
Continuous Drain Current (T ₁ = 150 °C)	T _C = 25 °C	1-	- 25			
Continuous Drain Current $(1) = 130^{\circ}$ C)	T _C = 70 °C	I _D	- 17.3			
Pulsed Drain Current	I _{DM}	- 75	A			
Avalanche Current	I _{AS}	- 20				
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	19.2	mJ		
	T _C = 25 °C	D	37.1 ^b	w		
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D –	2.9			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)	R _{thJC}	2.9			

Notes:

a. Duty cycle ≤ 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).



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SPECIFICATIONS $T_J = 25^{\circ}$ Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	• • • • • •			.,,,,,,			
Drain-Source Breakdown Voltage	V _{DS}	V _{DS} = 0 V, I _D = - 250 μA	- 100				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
Zero Gate Voltage Drain Current		V _{DS} = - 100 V, V _{GS} = 0 V			- 1	-	
	I _{DSS}	V _{DS} = - 100 V, V _{GS} = 0 V, T _J = 125 °C			- 50 µA		
		V _{DS} = - 100 V, V _{GS} = 0 V, T _J = 150 °C			- 250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 10 V, V_{GS} = - 10 V	- 15			А	
		V _{GS} = - 10 V, I _D = - 3.6 A		0.08	0.09	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 3.4 A		0.09	0.10		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.6 A		16		S	
Dynamic ^b	I			I			
Input Capacitance	C _{iss}			1043		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 50 V, f = 1 MHz		65			
Reverse Transfer Capacitance	C _{rss}	1		41			
		$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.6 \text{ A}$		23.2	34.8	nC	
Total Gate Charge ^c				11.7	17.9		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -50$ V, $V_{GS} = -4.5$ V, $I_{D} = -3.6$ A		3.5			
Gate-Drain Charge ^c	Q _{gd}			4.8			
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			7	14		
Rise Time ^c	t _r	V_{DD} = - 50 V, R _L = 17.2 Ω		12	18		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 2.9 A, V_{GEN} = - 10 V, R_g = 1 Ω		33	50	- ns	
Fall Time ^c	t _f			9	18		
Drain-Source Body Diode Ratings an	nd Characteri	istics T _C = 25 °C ^b					
Continuous Current	۱ _S				- 20	٨	
Pulsed Current	I _{SM}				- 75	A	
Forward Voltage ^a	V _{SD}	I _F = - 2.9 A, V _{GS} = 0 V		- 0.8	- 1.5	V	
Reverse Recovery Time	t _{rr}			50	75	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	А	
Reverse Recovery Charge	Q _{rr}	1		98	147	nC	

Notes:

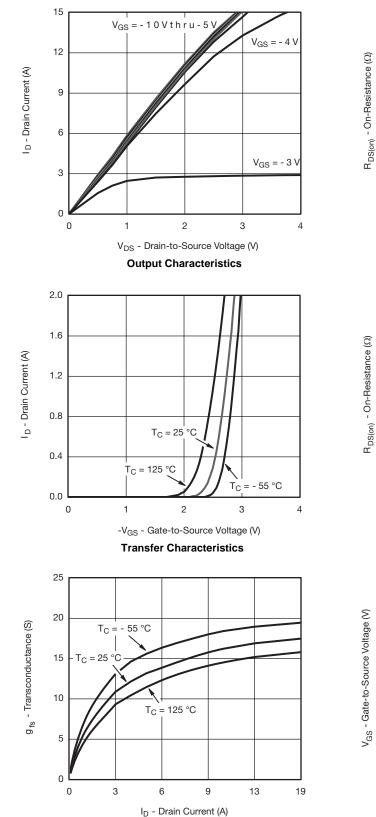
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

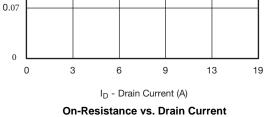
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 $V_{GS} = -10 V$



Transconductance

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

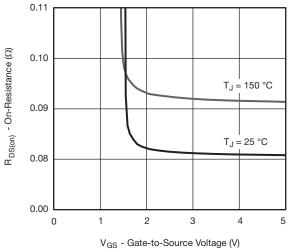


 $V_{GS} = -4.5$ V

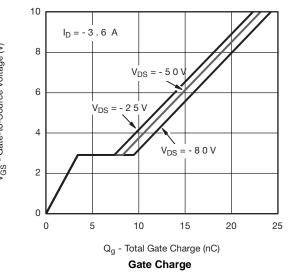
0.13

0.11

0.09

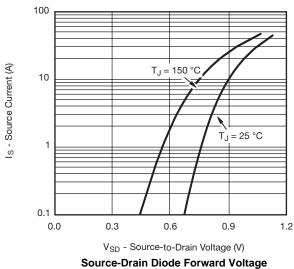


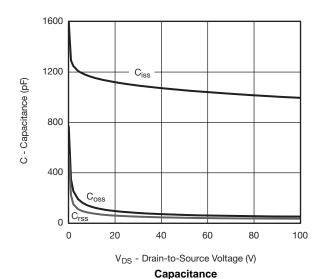
On-Resistance vs. Gate-to-Source Voltage

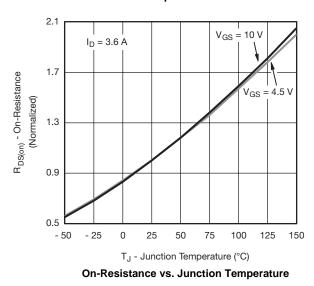


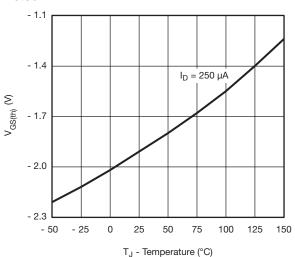
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

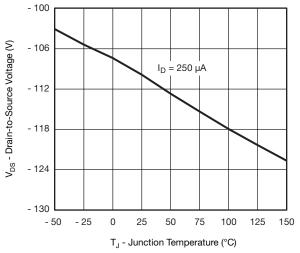




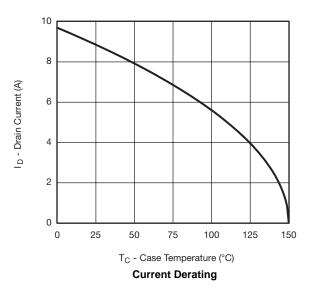




Threshold Voltage



Drain Source Breakdown vs. Junction Temperature



0.2

0.1 0.05

0.1 10-4

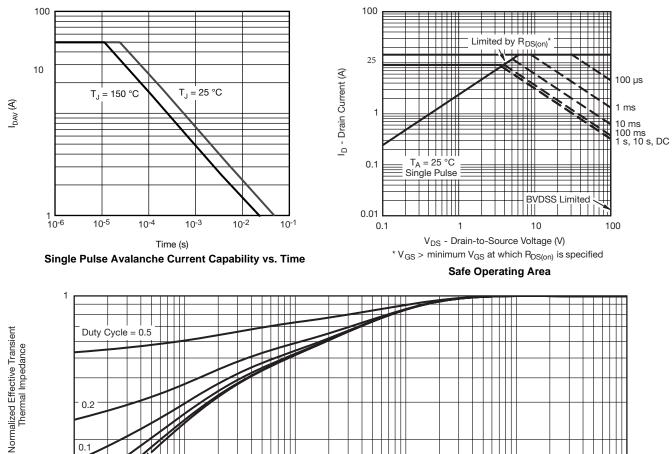
02 0. 111 Single Pulse

10⁻³

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10-2

10-1

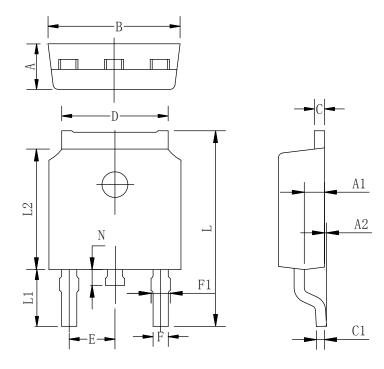
Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case

1

10

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TO-252-2L PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Тур	Max
Α	2.10	2.30	2.50
Al	0.88	1.01	1.16
A2	0.00	0.15	0.28
В	6.40	6.60	6.80
С	0.42	0.50	0.63
C1	0.42	0.50	0.63
D	5.08	5.32	5.65
Е		2.286 TYP	
F	0.63	0.76	0.89
F1	0.64	0.86	1.08
L	9.30	9.90	10.80
L1	2.4	2.8	3.6
L2	5.90	6.10	6.55
N	0.57	0.80	1.05

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